

### Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	40				$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.038		V/°C	Reference to 25°C, I <sub>D</sub> = 5mA <sup>②</sup>
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance		0.90	1.25	mΩ	$V_{GS} = 10V, I_D = 195A $ $\bigcirc$
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
gfs	Forward Transconductance	1300			S	$V_{DS} = 10V, I_{D} = 195A$
$R_G$	Internal Gate Resistance		2.0		Ω	
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 40V, V_{GS} = 0V$
				250		$V_{DS} = 40V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			100	nA	V <sub>GS</sub> = 20V
	Gate-to-Source Reverse Leakage			-100	Ì	$V_{GS} = -20V$

### Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
$\overline{Q_g}$	Total Gate Charge		160	240	nC	I <sub>D</sub> = 180A
$Q_{gs}$	Gate-to-Source Charge		42			V <sub>DS</sub> =20V
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		65			V <sub>GS</sub> = 10V ⑤
Q <sub>sync</sub>	Total Gate Charge Sync. (Q <sub>g</sub> - Q <sub>gd</sub> )		95			$I_D = 180A, V_{DS} = 0V, V_{GS} = 10V$
$t_{d(on)}$	Turn-On Delay Time		23		ns	$V_{DD} = 26V$
t <sub>r</sub>	Rise Time		240			$I_D = 240A$
t <sub>d(off)</sub>	Turn-Off Delay Time		91			$R_G = 2.7\Omega$
t <sub>f</sub>	Fall Time		160			V <sub>GS</sub> = 10V ⑤
C <sub>iss</sub>	Input Capacitance		9130		рF	$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		2020			$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		990			f = 1.0  MHz,  See Fig. 5
C <sub>oss</sub> eff. (ER)	Effective Output Capacitance (Energy Related) ⑦		2590			$V_{GS} = 0V$ , $V_{DS} = 0V$ to 32V $\bigcirc$ , See Fig. 11
C <sub>oss</sub> eff. (TR)	Effective Output Capacitance (Time Related)®		2650			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V $

#### Diode Characteristics

	blode Characteristics						
Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions	
Is	Continuous Source Current			400①	Α	MOSFET symbol	
	(Body Diode)					showing the	
I <sub>SM</sub>	Pulsed Source Current			1610	Α	integral reverse	
	(Body Diode) ②					p-n junction diode.	
$V_{SD}$	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C, I_S = 195A, V_{GS} = 0V $	
t <sub>rr</sub>	Reverse Recovery Time		49		ns	$T_J = 25^{\circ}C$ $V_R = 34V$ ,	
			51			$T_{\rm J} = 125^{\circ}{\rm C}$ $I_{\rm F} = 240{\rm A}$	
$Q_{rr}$	Reverse Recovery Charge		37		nC	$T_J = 25^{\circ}C$ di/dt = 100A/ $\mu$ s $\odot$	
			41			$T_{\rm J} = 125^{\circ}{\rm C}$	
I <sub>RRM</sub>	Reverse Recovery Current		3.2		Α	$T_J = 25^{\circ}C$	
t <sub>on</sub>	Forward Turn-On Time	Intrins	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

#### Notes:

- ① Calculated continuous current based on maximum allowable junction ⑤ Pulse width ≤ 400µs; duty cycle ≤ 2%. temperature. Bond wire current limit is 240A. Note that current limitations arising from heating of the device leads may occur with some lead mounting arrangements. (Refer to AN-1140)
- ② Repetitive rating; pulse width limited by max. junction temperature.
- $R_G = 25\Omega$ ,  $I_{AS} = 240A$ ,  $V_{GS} = 10V$ . Part not recommended for use above this value.
- $\textcircled{4} \ \ I_{SD} \leq 240 A, \ di/dt \leq 740 A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_{J} \leq 175^{\circ}C.$
- © Coss eff. (TR) is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- $\ensuremath{\mathfrak{D}}$  Coss eff. (ER) is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- ® When mounted on 1" square PCB (FR-4 or G-10 Material). For recom mended footprint and soldering techniques refer to application note #AN-994.
- $\ \, \mbox{\Large \ensuremath{\mathfrak{G}}} \ \, R_{\theta} \, \mbox{is measured at $T_J$ approximately $90^{\circ}$C} \, .$
- 1 R<sub> $\theta$ JC</sub> value shown is at time zero.



## Qualification Information<sup>†</sup>

			Automotive			
		(per AEC-Q101) <sup>††</sup>				
		Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
		D <sup>2</sup> PAK - 7 Pin	MSL1			
	Machine Model	Class M4 (+/- 800V) <sup>†††</sup>				
			AEC-Q101-002			
FOD	Human Body Model	Class H3A (+/- 6000V) <sup>†††</sup>				
ESD			AEC-Q101-001			
Charged Device Model			Class C5 (+/- 2000V) <sup>†††</sup>			
			AEC-Q101-005			
RoHS Compliant		Yes				

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <a href="http://www.irf.com/">http://www.irf.com/</a>

<sup>††</sup> Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

<sup>†††</sup> Highest passing voltage.



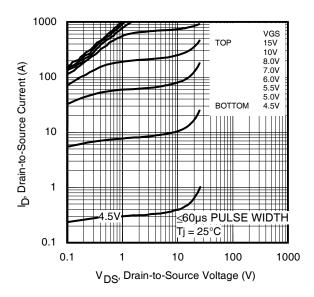


Fig 1. Typical Output Characteristics

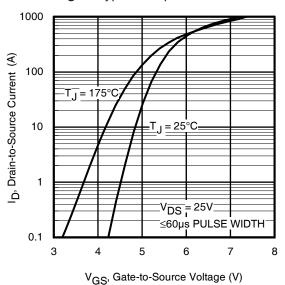


Fig 3. Typical Transfer Characteristics

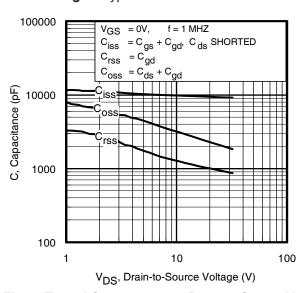


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

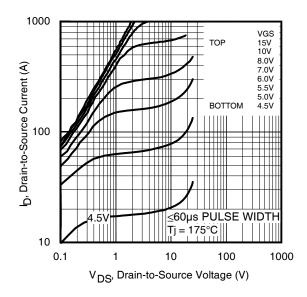


Fig 2. Typical Output Characteristics

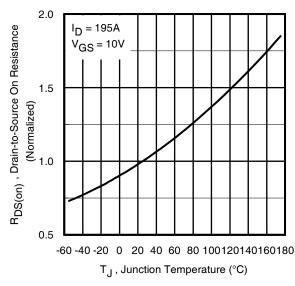


Fig 4. Normalized On-Resistance vs. Temperature

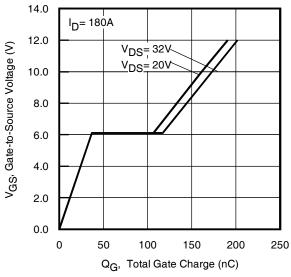
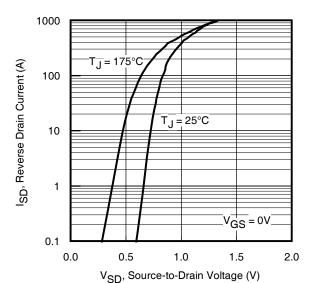
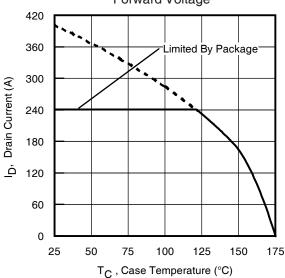


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage





**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 9.** Maximum Drain Current vs. Case Temperature

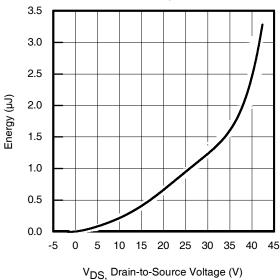


Fig 11. Typical C<sub>OSS</sub> Stored Energy

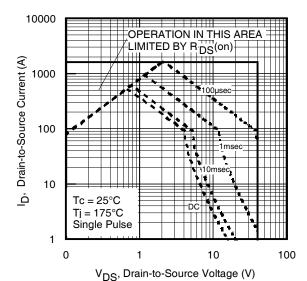


Fig 8. Maximum Safe Operating Area

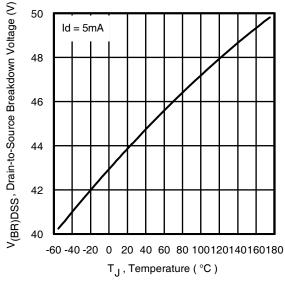


Fig 10. Drain-to-Source Breakdown Voltage

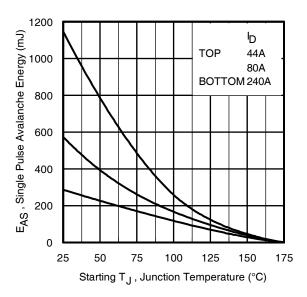


Fig 12. Maximum Avalanche Energy vs. DrainCurrent



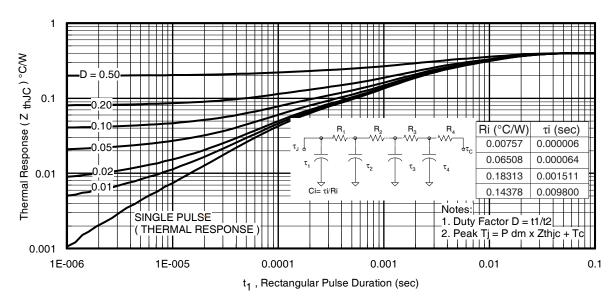


Fig 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

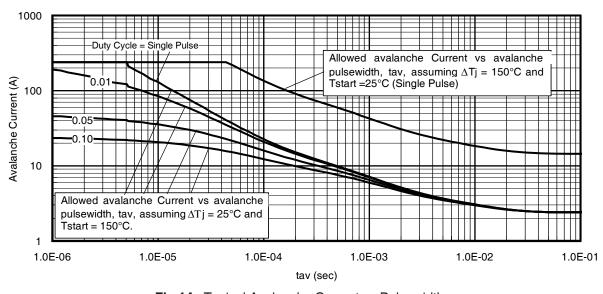


Fig 14. Typical Avalanche Current vs. Pulsewidth

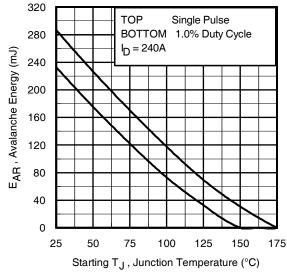


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
  - Purely a thermal phenomenon and failure occurs at a temperature far in excess of  $T_{jmax}$ . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT<sub>imax</sub> is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
- 4. P<sub>D (ave)</sub> = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. l<sub>av</sub> = Allowable avalanche current.
- 7.  $\Delta T$  = Allowable rise in junction temperature, not to exceed  $T_{jmax}$  (assumed as 25°C in Figure 14, 15).
  - t<sub>av</sub> = Average time in avalanche.
  - D = Duty cycle in avalanche =  $t_{av} \cdot f$
  - $Z_{th,JC}(D, t_{av})$  = Transient thermal resistance, see Figures 13)

$$\begin{split} P_{D \; (ave)} &= 1/2 \; (\; 1.3 \cdot BV \cdot I_{av}) = \triangle T / \; Z_{thJC} \\ I_{av} &= 2\triangle T / \; [1.3 \cdot BV \cdot Z_{th}] \\ E_{AS \; (AR)} &= P_{D \; (ave)} \cdot t_{av} \end{split}$$



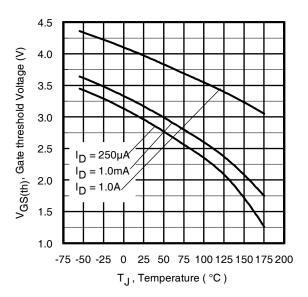


Fig 16. Threshold Voltage vs. Temperature

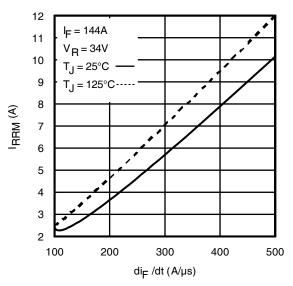


Fig. 18 - Typical Recovery Current vs. di<sub>f</sub>/dt

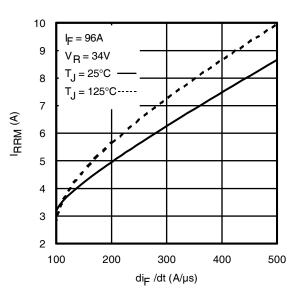


Fig. 17 - Typical Recovery Current vs. di<sub>f</sub>/dt

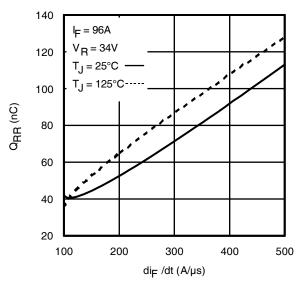


Fig. 19 - Typical Stored Charge vs. di<sub>f</sub>/dt

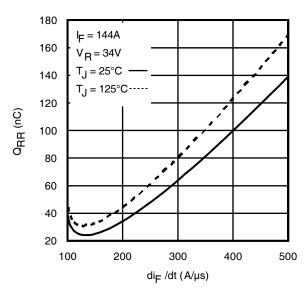


Fig. 20 - Typical Stored Charge vs. dif/dt



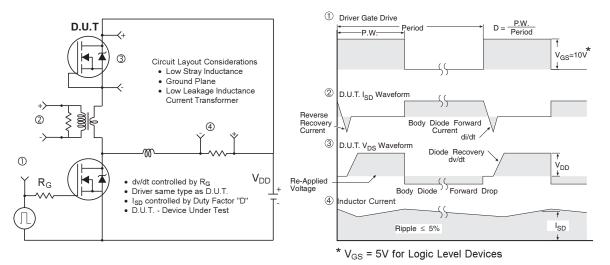


Fig 21. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

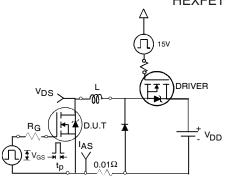


Fig 22a. Unclamped Inductive Test Circuit

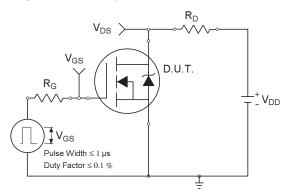


Fig 23a. Switching Time Test Circuit

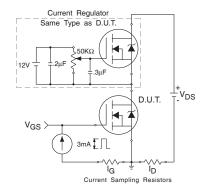


Fig 24a. Gate Charge Test Circuit

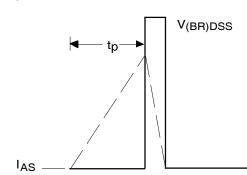


Fig 22b. Unclamped Inductive Waveforms

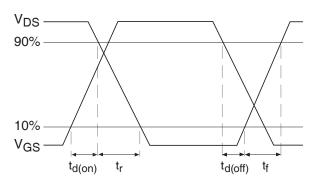


Fig 23b. Switching Time Waveforms

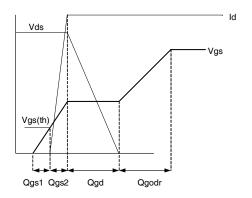
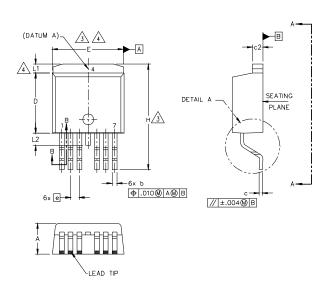


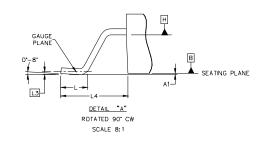
Fig 24b. Gate Charge Waveform

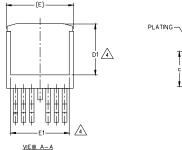


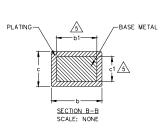
# D<sup>2</sup>Pak - 7 Pin Package Outline

Dimensions are shown in millimeters (inches)









5						
S	DIMENSIONS					
М В О L	MILLIMETERS		INC	O T E S		
L	MIN.	MAX.	MIN.	MAX.	S	
Α	4,06	4.83	.160	.190		
A1	-	0.254	_	.010		
b	0.51	0.99	.020	.036		
b1	0.51	0.89	.020	.032	5	
С	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	5	
c2	1.14	1.65	.045	.065		
D	8.38	9.65	.330	.380	3	
D1	6.86	-	.270		4	
Ε	9.65	10.67	.380	.420	3,4	
E1	6.22	-	.245		4	
e	1.27 BSC		.050	BSC		
Н	14.61	15.88	.575	.625		
L	1.78	2.79	.070	.110		
L1	-	1.68	-	.066	4	
L2	-	1.78	_	.070		
L3	0.25 BSC		.010	BSC		
L4	4.78	5.28	.188	.208		

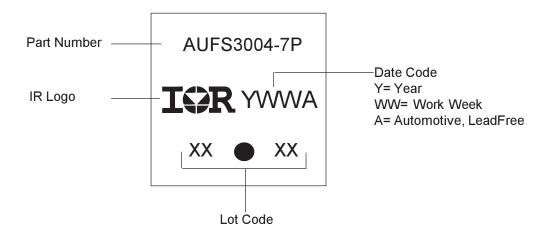
#### NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- Jimension D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
- 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
- 5. DIMENSION 61 AND c1 APPLY TO BASE METAL ONLY.
  - 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
  - 7. CONTROLLING DIMENSION: INCH.
  - 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263CB.

Note: For the most current drawing please refer to IR website at <a href="http://www.irf.com/package/">http://www.irf.com/package/</a>



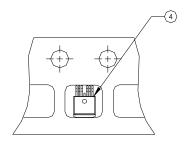
## D<sup>2</sup>Pak - 7 Pin Part Marking Information



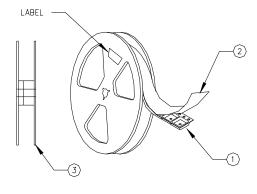
# D<sup>2</sup>Pak - 7 Pin Tape and Reel

NOTES, TAPE & REEL, LABELLING:

- 1. TAPE AND REEL.
  - 1.1 REEL SIZE 13 INCH DIAMETER.
  - 1.2 EACH REEL CONTAINING 800 DEVICES.
  - 1.3 THERE SHALL BE A MINIMUM OF 42 SEALED POCKETS CONTAINED IN THE LEADER AND A MINIMUM OF 15 SEALED POCKETS IN THE TRAILER.
  - 1.4 PEEL STRENGTH MUST CONFORM TO THE SPEC. NO. 71-9667.
  - 1.5 PART ORIENTATION SHALL BE AS SHOWN BELOW.
  - 1.6 REEL MAY CONTAIN A MAXIMUM OF TWO UNIQUE LOT CODE/DATE CODE COMBINATIONS.
    REWORKED REELS MAY CONTAIN A MAXIMUM OF THREE UNIQUE LOT CODE/DATE CODE COMBINATIONS.
    HOWEVER, THE LOT CODES AND DATE CODES WITH THEIR RESPECTIVE QUANTITIES SHALL APPEAR ON THE BAR CODE LABEL FOR THE AFFECTED REEL.



- 2. LABELLING (REEL AND SHIPPING BAG).
  - 2.1 CUST. PART NUMBER (BAR CODE): IRFXXXXSTRL-7P
  - 2.2 CUST. PART NUMBER (TEXT CODE): IRFXXXXSTRL-7P
  - 2.3 I.R. PART NUMBER: IRFXXXXSTRL-7P
  - 2.4 QUANTITY:
  - 2.5 VENDOR CODE; IR
  - 2.6 LOT CODE:
  - 2.7 DATE CODE:



Note: For the most current drawing please refer to IR website at: <a href="http://www.irf.com/package/">http://www.irf.com/package/</a>



#### IMPORTANT NOTICE

Unless specifically designated for the automotive market, International Rectifier Corporation and its subsidiaries (IR) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or services without notice. Part numbers designated with the "AU" prefix follow automotive industry and/or customer specific requirements with regards to product discontinuance and process change notification. All products are sold subject to IR's terms and conditions of sale supplied at the time of order acknowledgment.

IR warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with IR's standard warranty. Testing and other quality control techniques are used to the extent IR deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

IR assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using IR components. To minimize the risks with customer products and applications, customers should provide adequate design and operating safeguards.

Reproduction of IR information in IR data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alterations is an unfair and deceptive business practice. IR is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of IR products or serviced with statements different from or beyond the parameters stated by IR for that product or service voids all express and any implied warranties for the associated IR product or service and is an unfair and deceptive business practice. IR is not responsible or liable for any such statements.

IR products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or in any other application in which the failure of the IR product could create a situation where personal injury or death may occur. Should Buyer purchase or use IR products for any such unintended or unauthorized application, Buyer shall indemnify and hold International Rectifier and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that IR was negligent regarding the design or manufacture of the product.

Only products certified as military grade by the Defense Logistics Agency (DLA) of the US Department of Defense, are designed and manufactured to meet DLA military specifications required by certain military, aerospace or other applications. Buyers acknowledge and agree that any use of IR products not certified by DLA as military-grade, in applications requiring military grade products, is solely at the Buyer's own risk and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

IR products are neither designed nor intended for use in automotive applications or environments unless the specific IR products are designated by IR as compliant with ISO/TS 16949 requirements and bear a part number including the designation "AU". Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, IR will not be responsible for any failure to meet such requirements.

For technical support, please contact IR's Technical Assistance Center <a href="http://www.irf.com/technical-info/">http://www.irf.com/technical-info/</a>

#### WORLD HEADQUARTERS:

101 N. Sepulveda Blvd., El Segundo, California 90245 Tel: (310) 252-7105



### **Revision History**

Date	Comments			
3/4/2015	Updated datasheet based on new IR corporate template .			
3/4/2015	• Updated part marking from "AUS3004-7P" to "AUFS3004-7P" on page 10.			